



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVsss	Rss(on) Typ	Is _{Max} T _A = +25°C
12V	4.3mΩ @ V _{GS} = 3.8V	15.5A

Description

This new generation MOSFET is designed to minimize the on-state resistance (Rss(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

Applications

- Battery managements
- Load switches
- Battery protections

Features

- CSP with Footprint 2.70mm × 1.81mm
- Height = 0.21mm for Low Profile
- ESD Protection of Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

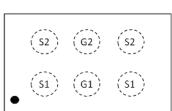
https://www.diodes.com/quality/product-definitions/

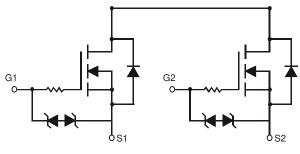
Mechanical Data

- Package: X3-DSN2718-6
- Terminal Connections: See Diagram Below
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiAu. Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.0026 grams (Approximate)









Top View Equivalent Circuit

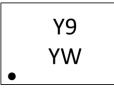
Ordering Information (Note 4)

Don't Normalism	Paralisa ma	Packing		
Part Number	Package	Qty.	Carrier	
DMN16M8UCA6-7	X3-DSN2718-6	3000	Tape & Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See http://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Y9 = Product Type Marking Code YW = Date Code Marking Y or <u>Y</u> = Year (ex: 3 = 2023)

W or \overline{W} = Week (ex: a = week 27; z represents week 52 and 53)

Date Code Key

Γ	Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
	Code	2	3	4	5	6	7	8	9	0	1	2	3

Week	1-26	27-52	53
Code	A-Z	a-z	Z



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit			
Source-Source Voltage	Vsss	12	V			
Gate-Source Voltage			V _{GSS}	V		
Gate-Source Voltage (Note 5)	Vgss	±10.5	V			
Continuous Courses Coursest (Nata C) V	Steady	$T_A = +25^{\circ}C$	Is	15.5	Α	
Continuous Source Current (Note 6) V _{GS} = 4.5V	State	T _A = +70°C		12.5		
Continuous Courses Coursest (Nata C) Vos. 0 FV	Steady $T_A = +25^\circ$		1-	13.0	Δ.	
Continuous Source Current (Note 6) V _{GS} = 2.5V	State	T _A = +70°C	Is	10.5	Α	
Pulsed Source Current (Note 7)	lsм	80	Α			

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 8)	PD	1.1	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 8)	Reja	117	°C/W
Power Dissipation (Note 6)	PD	2.1	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6)	Reja	60	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

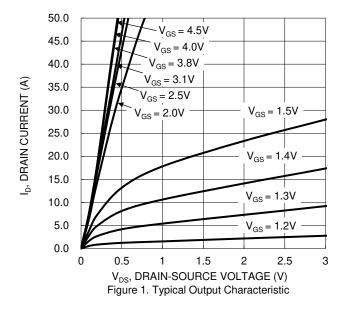
<u> </u>			_	1		T 10 III	
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)	1		1	1	1	T	
Source-Source Breakdown Voltage	BVsss	12	_	_	V	$V_{GS} = 0V$, $I_{S} = 1mA$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{SSS}	_	_	1	μΑ	$V_{SS} = 10V$, $V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 8V$, $V_{SS} = 0V$	
date-Source Leakage	Igss	_	_	±1	μΑ	$V_{GS} = \pm 5V$, $V_{SS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	0.5	0.7	1.3	V	Vss = 6V, $Is = 1mA$	
		3.1	4.2	5.6		V _{GS} = 4.5V, I _S = 3A	
Static Source-Source On-Resistance	Danie	3.2	4.3	6.0	mΩ	$V_{GS} = 3.8V, I_{S} = 3A$	
Static Source-Source On-Resistance	Rss(on)	3.6	4.5	7.0		V _G S = 3.1V, I _S = 3A	
		4.2	5.0	8.0		V _G S = 2.5V, I _S = 3A	
Diode Forward Voltage	Vss	_	0.7	1.2	V	Vgs = 0V, Is = 3A	
DYNAMIC CHARACTERISTICS (Note 10)				•			
Input Capacitance	Ciss	_	2333	_		., ., .,	
Output Capacitance	Coss	_	742	_	pF	Vss = 6V, Vgs = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	175	_		1 = 1.01/11 12	
Total Gate Charge	Qg	_	45.4	_			
Gate-Source Charge	Q _{gs}	_	9.3	_	nC	$V_{SS} = 6V, V_{GS} = 4.5V,$	
Gate-Drain Charge	Qgd	_	9.9	_	110	Is = 18A	
Gate Charge at VTH	Q _g (TH)	_	5.8	_			
Turn-On Delay Time	t _{D(ON)}	_	476	_			
Turn-On Rise Time	tr	_	1892	_		$V_{SS} = 6V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	tD(OFF)	_	6127	_	ns	Is = 3A	
Turn-Off Fall Time	tF	_	4640	_			

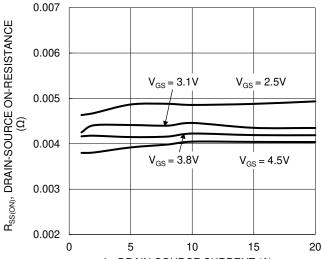
Notes:

- 5. $t = 10\mu s$, Duty Cycle $\leq 1 \%$.

- 6. Device mounted on FR-4 material with 1inch² (6.45cm²), 2oz. (0.071mm thick) Cu.
 7. Repetitive rating, pulse width limited by junction temperature.
 8. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
 9. Short duration pulse test used to minimize self-heating effect.
 10. Guaranteed by design. Not subject to production testing.







I_D, DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

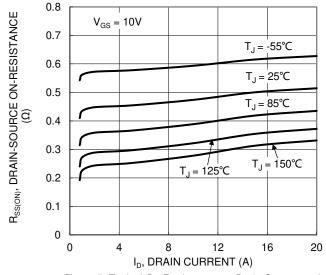
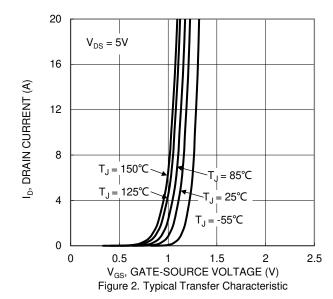
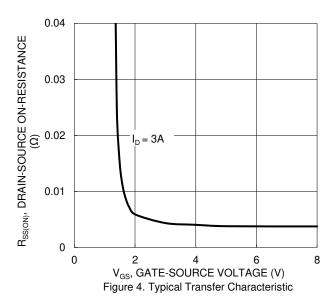


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





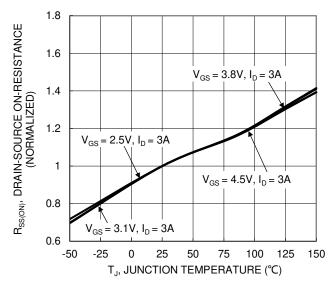


Figure 6. On-Resistance Variation with Junction Temperature



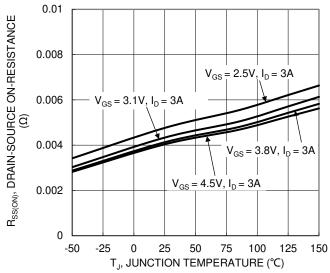
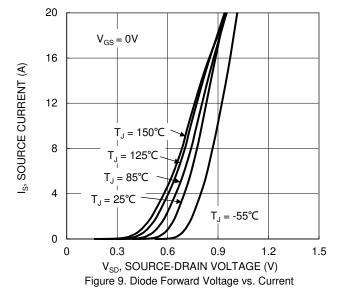
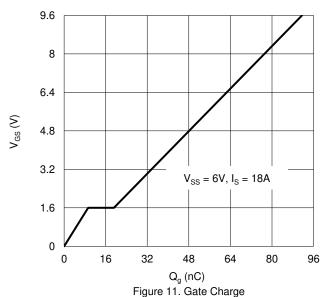


Figure 7. On-Resistance Variation with Junction Temperature





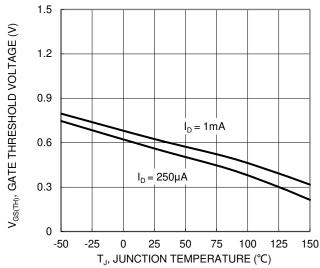
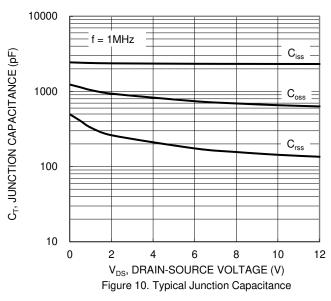
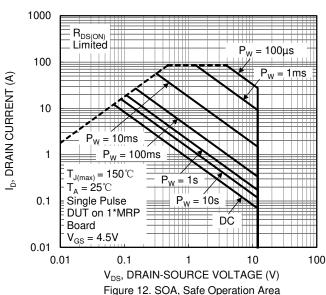


Figure 8. Gate Threshold Variation vs. Junction Temperature







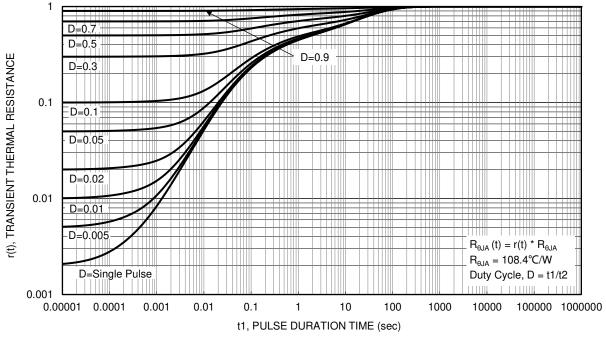


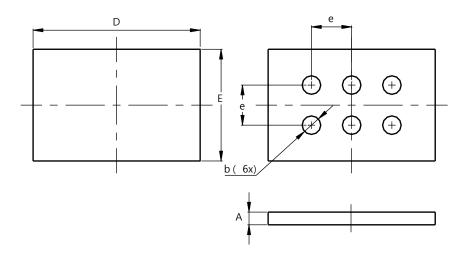
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-DSN2718-6

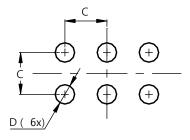


X3-DSN2718-6							
Dim	Min	Max	Тур				
Α	0.16	0.26	0.21				
b	0.27	0.33	0.30				
D	2.65	2.75	2.70				
Е	1.76	1.86	1.81				
е	0.62	0.68	0.65				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-DSN2718-6



Dimensions	Value (in mm)		
С	0.65		
D	0.30		



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